

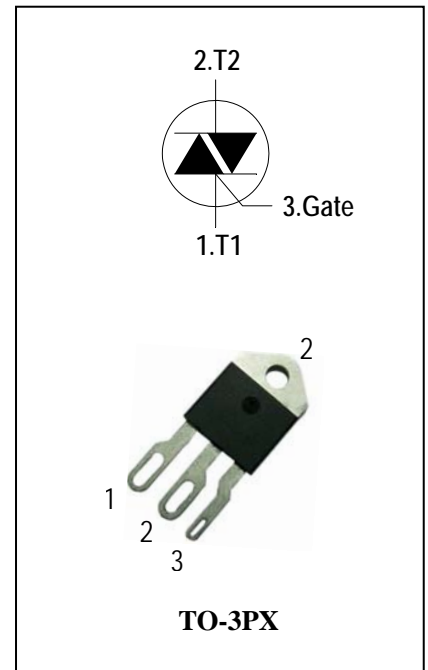
## 3 Quadrants Triacs

### General Description

High current density due to mesa technology .the ADT40C triac series is suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, High power motor controls e.g. washing machines and vacuum cleaners, Rectifier-fed DC inductive loads e.g. DC motors and solenoids , motor speed controllers.

### Features

- ◆ Repetitive Peak Off-State Voltage: 600V and 800V
- ◆ R.M.S On-State Current (  $I_{T(RMS)} = 40A$  )
- ◆ High Commutation  $dv/dt$
- ◆ These Devices are Pb-Free and are RoHS Compliant



### Absolute Maximum Ratings

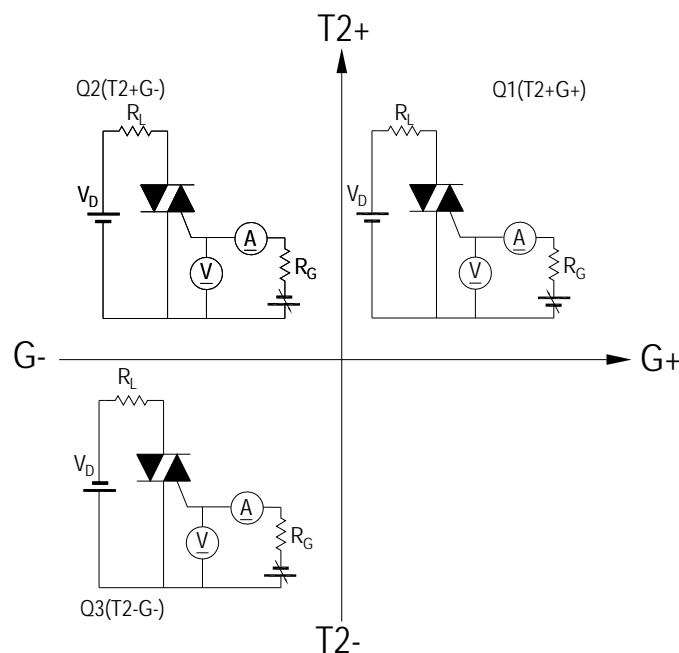
Symbol	Items	Conditions	Ratings	Unit
$V_{DRM}$ $V_{RRM}$	Repetitive Peak Off-State Voltage	$T_j = 25^\circ C$	ADT40C60X 600 ADT40C80X 800	V V
$I_{T(RMS)}$	R.M.S On-State Current	$T_C = 95^\circ C$	40	A
$I_{TSM}$	Surge On-State Current	$t_p = 20ms(50Hz) / t_p = 16.7ms(60Hz)$	400/420	A
$I^2t$	$I^2t$ for fusing	$t_p = 10ms$	880	$A^2s$
$di/dt$	Critical rate of rise of on-state current	$F = 120 Hz$ $T_j = 125^\circ C$ $I_G = 2 \times I_{GT}$ , $t_r \leq 100 ns$	55	$A/\mu s$
$I_{GM}$	Peak Gate Current	$t_p = 20 \mu s$ $T_j = 125^\circ C$	8	A
$P_{G(AV)}$	Average Gate Power Dissipation( $T_j = 125^\circ C$ )		1	W
$P_{GM}$	Peak Gate Power Dissipation( $t_p = 20\mu s, T_j = 125^\circ C$ )		10	W
$T_j$	Operating Junction Temperature		- 40 ~ 125	$^\circ C$
$T_{STG}$	Storage Temperature		- 40 ~ 150	$^\circ C$



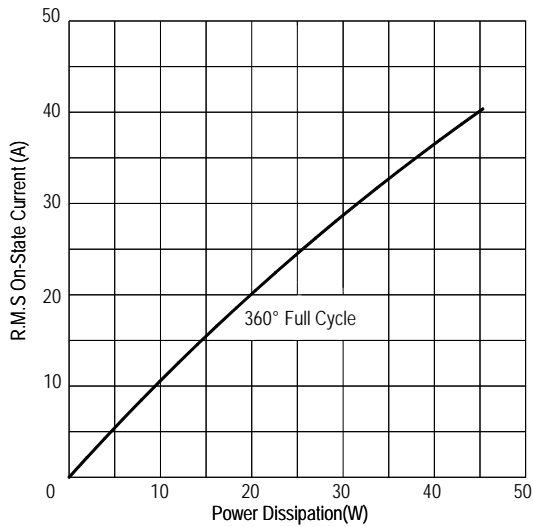
## Electrical Characteristics (T<sub>j</sub> = 25°C unless otherwise specified)

Symbol	Items		Conditions		ADT40C60XB/80XB	Unit
I <sub>DRM</sub>	Peak Forward Reverse Blocking Current		V <sub>DRM</sub> = V <sub>RRM</sub> , T <sub>j</sub> = 25°C	Max.	5	uA
I <sub>RRM</sub>			V <sub>DRM</sub> = V <sub>RRM</sub> , T <sub>j</sub> = 125°C		5	mA
V <sub>TM</sub>	Peak On-State Voltage		I <sub>TM</sub> = 60A, t <sub>p</sub> = 380 μs	Max.	1.55	V
V <sub>GD</sub>	Q1-Q2-Q3	Non-Trigger Gate Voltage	V <sub>D</sub> = V <sub>DRM</sub> R <sub>L</sub> = 3.3 kΩ T <sub>j</sub> = 125°C	Min.	0.2	V
V <sub>GT</sub>	Q1-Q2-Q3	Gate Trigger Voltage	V <sub>D</sub> = 12V , R <sub>L</sub> = 33Ω	Max.	1.3	V
I <sub>GT</sub>	Q1-Q2-Q3	Gate Trigger Current		Max.	50	mA
I <sub>H</sub>	Q1-Q2-Q3	Holding Current	I <sub>T</sub> = 0.5A	Max.	75	mA
I <sub>L</sub>	Q1-Q3	Latching Current	I <sub>G</sub> = 1.2 I <sub>GT</sub>	Max.	90	mA
	Q2				110	
dV/dt	Critical Rate of Rise of Off-State Voltage		V <sub>D</sub> = 2/3V <sub>DRM</sub> gate open T <sub>j</sub> = 125°C	Min.	1500	V/μs
(dV/dt) <sub>c</sub>	Critical Rate of Change of Commutating Voltage		(dI/dt) <sub>c</sub> = -20A/ms T <sub>j</sub> = 125°C	Min.	20	V/μs
R <sub>th(j-c)</sub>	Junction to case (AC)			Max.	0.6	°C/W
R <sub>th(j-a)</sub>	Junction to ambient			Max.	50	°C/W

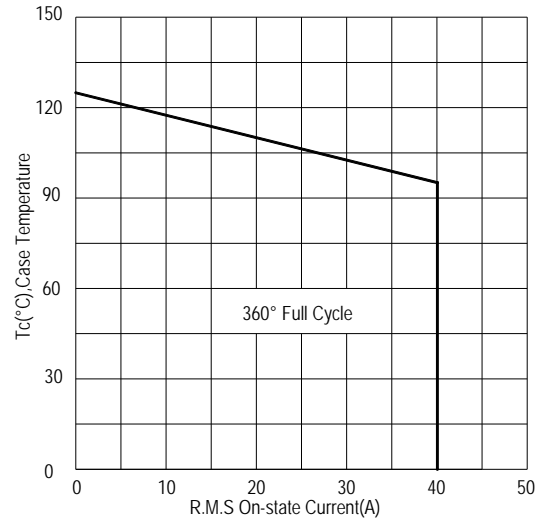
FIG.1: Triac quadrant are defined and the gate trigger test circuit



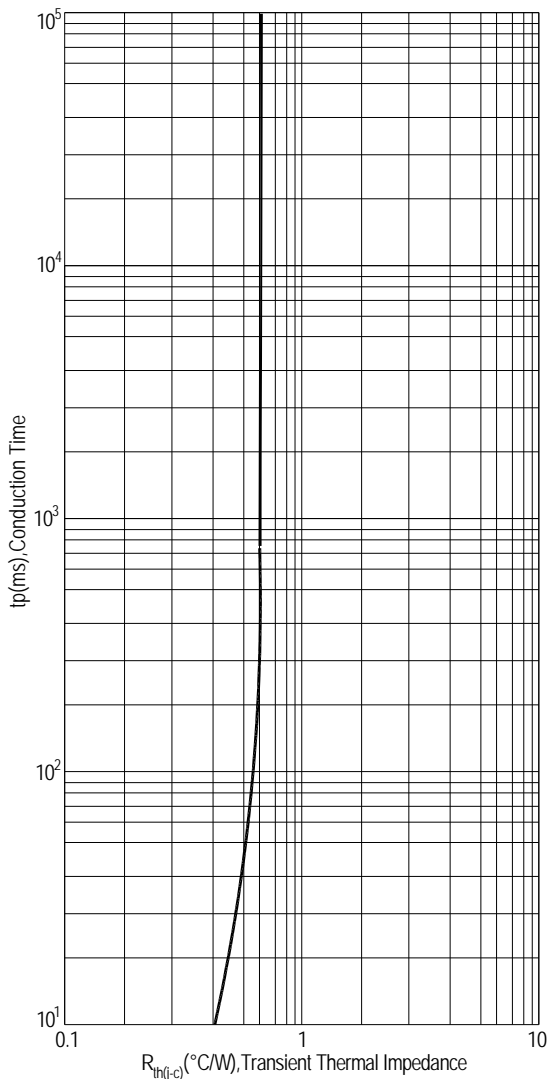
**FIG.2: Maximum on-state power dissipation**



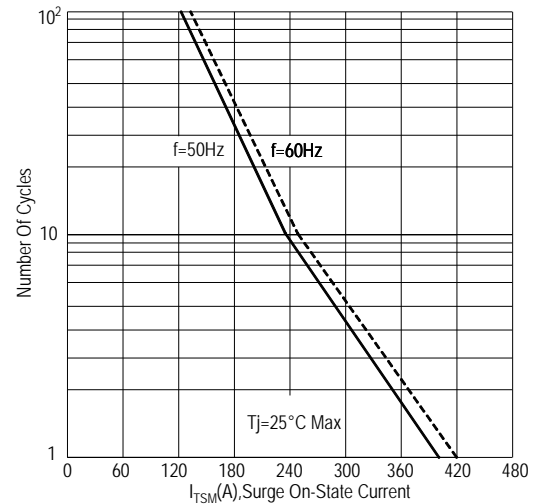
**FIG.3: Typical RMS on-state current VS Allowable case Temperature**



**FIG.4: Maximum transient thermal impedance**



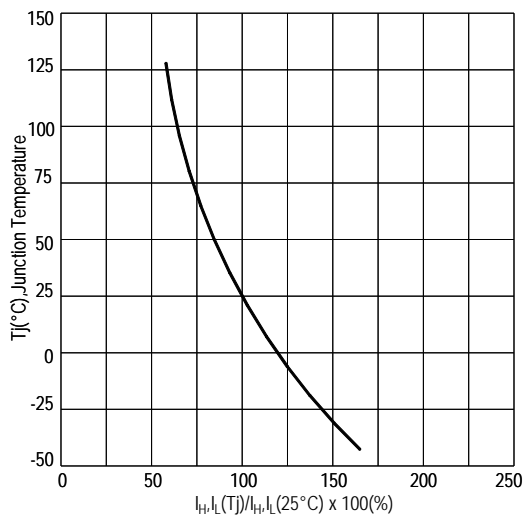
**FIG.5: Rated surge on-state current (Non-Repetitive)**



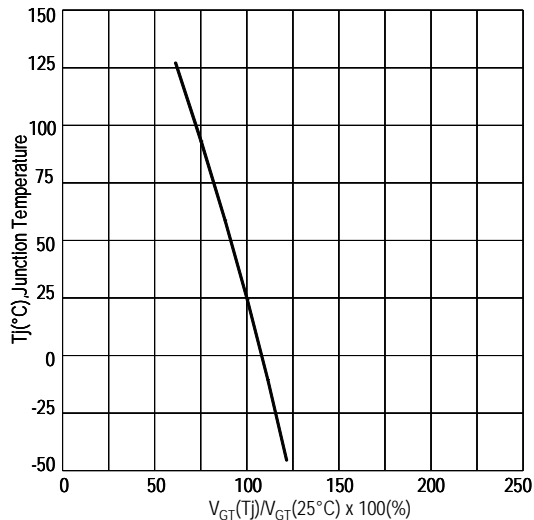
**FIG.6: Gate trigger current VS Junction temperature**



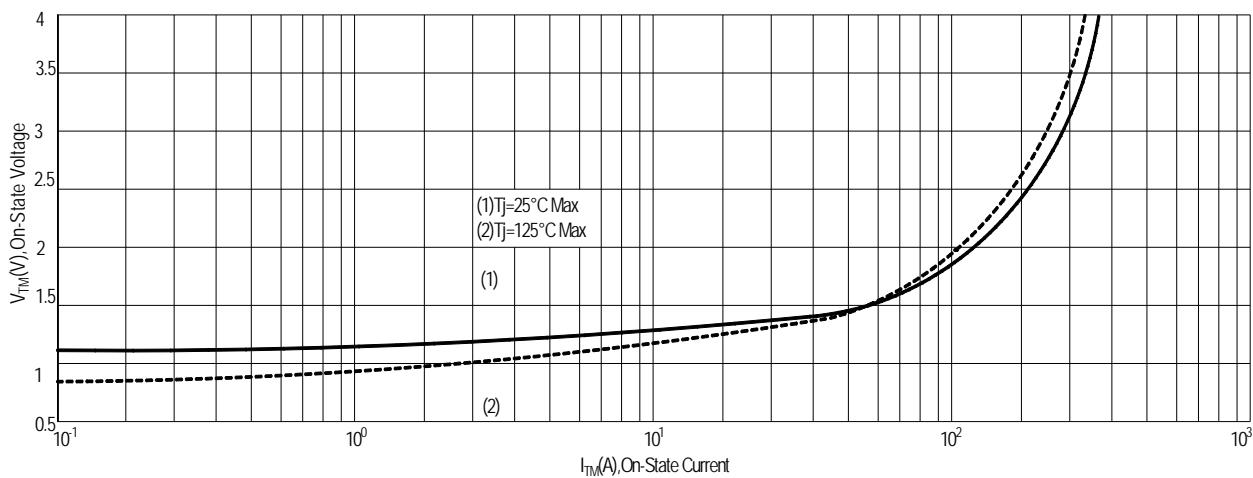
**FIG.7: Holding current and Latching current VS Junction temperature**



**FIG.8: Gate trigger voltage VS Junction temperature**

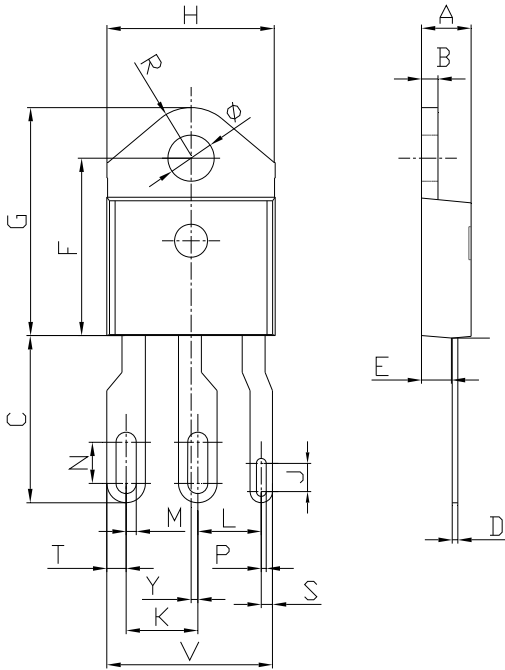


**FIG.9: On-state characteristics(Max)**



## PACKAGE MECHANICAL DATA

### TO-3PX Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.40	4.60	0.173	0.181
B	1.45	1.55	0.057	0.061
C	14.35	15.60	0.565	0.614
D	0.50	0.70	0.020	0.028
E	2.70	2.90	0.106	0.114
F	15.80	16.50	0.622	0.650
G	20.40	21.10	0.815	0.831
H	15.10	15.50	0.594	0.610
J	2.87	3.07	0.113	0.121
K	6.50	6.71	0.256	0.264
Ø	4.08	4.20	0.161	0.165
L	5.58	5.79	0.220	0.228
P	0.43	0.53	0.017	0.020
N	4.29	4.49	0.169	0.177
M	1.015	1.12	0.040	0.044
T	1.98	2.11	0.078	0.083
Y	0.71	0.81	0.028	0.032
V	15.31	15.70	0.603	0.618
S	1.09	1.22	0.086	0.096
R	4.60 typ.		0.181 typ.	

### Making Diagram

**ADV**: Logo  
**ADT40C60XB**: Part number  
**X**: Internal control code  
**H**: Halogen Free

AD T 40 C 60 X B

**ADVANCED**  
 Internal control code  
 Current: 40=40A  
 Quadrant: C=3Q  
 Voltage: 60=600V 80=800V

Sensitivity and type:  
 B=50mA  
 Package explain: X=TO-3PX

### Ordering information

Part number	Package	Marking	Packing	Quantity
ADT40C60XB	TO-3PX	ADT40C60XB	Tube	30pcs
ADT40C80XB	TO-3PX	ADT40C80XB	Tube	30pcs

Note: B = Gate Trigger Current Sensitivity and type

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